

## **VEHICULAR 2014**

### **Committee**

#### **VEHICULAR Advisory Committee**

Sriram Chellappan, Missouri University of Science and Technology, USA  
João Dias, Universidade de Aveiro, Portugal  
Carl James Debono, University of Malta - Msida, Malta  
Hassan Ghasemzadeh, Washington State University, USA  
Johan Lukkien, Eindhoven University of Technology, The Netherlands  
Matthias Uwe Pätzold, University of Agder - Grimstad, Norway  
Tapani Ristaniemi, University of Jyväskylä, Finland  
Hwangjun Song, POSTECH (Pohang Univ of Science and Technology) - Pohang, Korea

#### **VEHICULAR Industry/Research Chairs**

Andre Weimerskirch, ESCRYPT Inc., USA  
Alexandre Bouard, BMW Forschung und Technik GmbH, Germany  
Daniel Jiang, Mercedes-Benz Research & Development North America, USA  
Peter Knapik, Volkswagen AG, Germany  
Norbert Bissmeyer, Fraunhofer SIT, Germany  
An He, Qualcomm, USA  
Khelifa Hettak, Industry Canada / Communications Research Centre - Nepean, Canada  
Wenjing Wang, Blue Coat Systems, Inc., USA

#### **VEHICULAR Publicity Chairs**

Sangmi Moon, Chonnam National University, South Korea

#### **VEHICULAR 2014 Technical Program Committee**

Aydin Akan, Istanbul University, Turkey  
Waleed Alasmary, University of Toronto, Canada  
Marica Amadeo, University of Reggio Calabria, Italy  
Andrea Baiocchi, SAPIENZA University of Rome, Italy  
Irina Balan, Ghent University - IBBT, Belgium  
Gaurav Bansal, Toyota InfoTechnology Center, USA  
Michel Basset, Université de Haute Alsace, France  
Melike Baykal-Gursoy, Rutgers University, USA  
Monique Becker, Institut Mines Telecom, France  
Luis Bernardo, Universidade Nova of Lisboa, Portugal

Yuanguo Bi, Northeastern University, China  
Norbert Bissmeyer, Fraunhofer SIT, Germany  
Pascal Bodin, Orange Labs, France  
Ghaleb Bolos, ESIGELEC, France  
Mélanie Bouroche, Trinity College Dublin, Ireland  
Robert Budde, TU Dortmund University, Germany  
Darcy M. Bullock, Purdue University, USA  
Chiara Buratti, DEIS, University of Bologna, Italy  
Maria Calderon, University Carlos III of Madrid, Spain  
Claudia Campolo, University of Reggio Calabria, Italy  
Jean Pierre Cances, University of Limoges, France  
Lien-Wu Chen, Feng Chia University - Taichung, Taiwan  
Ray-Guang Cheng, National Taiwan University of Science and Technology - Taipei, Taiwan, R.O.C.  
Yonggang Chi, Harbin Institute of Technology, China  
Dong Ho Cho, Korea Advanced Institute of Science and Technology - Daejeon, Republic of Korea  
Juan Antonio Cordero Fuertes, INRIA, France  
Naim Dahnoun, University of Bristol, UK  
Carl James Debono, University of Malta - Msida, Malta  
Stefan Dietzel, University of Ulm, Germany  
David Hung-Chang Du, University of Minnesota, USA  
Trung Q. Duong, Blekinge Institute of Technology, Sweden  
Weiwei Fang (方维维), Beijing Jiaotong University (BJTU) - Beijing, China  
Michel Ferreira, University of Porto and Instituto de Telecomunicações, Portugal  
Alois Ferscha, Institut für Pervasive Computing, Johannes Kepler Universität Linz, Austria  
Serge Fdida, UPMC Sorbonne University, France  
Malgorzata Gajewska, Gdansk University of Technology, Poland  
Slawomir Gajewski, Gdansk University of Technology, Poland  
Hassan Ghasemzadeh, Washington State University, USA  
Athanasios Gkelias, Imperial College London, UK  
Benjamin Glas, ETAS GmbH, Germany  
Javier Gozalvez, UWICORE Laboratory, University Miguel Hernandez of Elche, Spain  
An He, Qualcomm, USA  
Khelifa Hettak, Industry Canada / Communications Research Centre - Nepean, Canada  
Daesik Hong, Yonsei University - Seoul, Korea  
Javier Ibanez-Guzman, Renault S.A., France  
Satish Chandra Jha, Intel Corporation, USA  
Daniel Jiang, Mercedes-Benz Research & Development North America, USA  
Felipe Jimenez, Technical University of Madrid (UPM), Spain  
Georgios Karagiannis, University of Twente, The Netherlands  
Gunes Karabulut Kurt, Istanbul Technical University - Istanbul, Turkey  
Frank Kargl, University of Ulm, Germany  
Wolfgang Kiess, DOCOMO Euro-Labs, Germany  
Jungwoo Lee, Seoul National University, Korea

XiangYang Li, Illinois Institute of Technology - Chicago, USA  
Qilian Liang, University of Texas at Arlington, USA  
Kuang-Hao Lin, National Chin-Yi University of Technology, Taiwan  
Thomas Little, Boston University, USA  
Rongxing Lu, University of Waterloo, Canada  
Johan Lukkien, Eindhoven University of Technology, The Netherlands  
Barbara M. Masini, CNR - IEIIT, University of Bologna, Italy  
João Mendes-Moreira, Universidade do Porto and LIAAD-INESC TEC L.A., Portugal  
Ingrid Moerman, Ghent University - IBBT, Belgium  
John Morris, Mahasarakham University, Thailand  
Hidekazu Murata, Kyoto University, Japan  
Jose Eugenio Naranjo Hernandez, Universidad Politecnica de Madrid, Spain  
Arnaldo Oliveira, Universidade de Aveiro, Portugal  
Shumao Ou, Oxford Brookes University, UK  
Mohammad Patwary, Staffordshire University, UK  
Matthias Uwe Pätzold, University of Agder - Grimstad, Norway  
Marco Picone, University of Parma, Italy  
Adrian Popescu, Blekinge Institute of Technology - Karlskrona, Sweden  
Ravi Prakash, University of Texas at Dallas, USA  
M. Elena Renda, IIT - CNR - Pisa, Italy  
Tapani Ristaniemi, University of Jyväskylä, Finland  
Marco Rocchetti, University of Bologna, Italy  
Vitor Santos, University of Aveiro, Portugal  
Susana Sargento, University of Aveiro, Portugal  
Miguel Sepulcre, University Miguel Hernandez of Elche, Spain  
Won-Yong Shin, Harvard University, USA  
Marcin Sokół, Gdansk University of Technology, Poland  
Hwangjun Song, POSTECH (Pohang Univ of Science and Technology) - Pohang, Korea  
Kemal Ertugrul Tepe, University of Windsor, Canada  
Necmi Taspinar, Erciyes University - Kayseri, Turkey  
Olav Tirkkonen, Aalto University, Finland  
Theodoros A. Tsiftsis, Technological Educational Institute of Lamia, Greece  
Carlo Vallati, University of Pisa, Italy  
Wantanee Viriyasitavat, Mahidol University, Thailand  
Ljubo Vlacic, Griffith University, Australia  
Wenjing Wang, Blue Coat Systems, Inc., USA  
You-Chiun Wang, National Sun Yat-Sen University, Taiwan  
Andre Weimerskirch, University of Michigan Transportation Research Institute (UMTRI), USA  
Chih-Yu Wen, National Chung Hsing University - Taichung, Taiwan  
Yue Wu, Shanghai Jiaotong University, China  
Weidong Xiang, University of Michigan - Dearborn, USA  
Jinyao Yan, Communication University of China, China  
Zheng Yan, Aalto University - Espoo, Finland / Xidian University Xi'an, China  
Wei Yuan, Huazhong University of Science and Technology - Wuhan, China

Peng Zhang, Xi`An University of Posts and Telecommunications (XUPT), China

Wensheng Zhang, Iowa State University, USA

Zhangbing Zhou, China University of Geosciences - Beijing, China & TELECOM SudParis, France

Haojin Zhu, Shanghai Jiao Tong University, China

Yanmin Zhu, Shanghai Jiao Tong University, China